

**Absolute Maximum Ratings** (Voltage relative to GND, @T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Supply Voltage	V <sub>IN</sub>	-0.3 to 100	V
Continuous Input & Output Current	I <sub>IN</sub> , I <sub>OUT</sub>	750	mA
Peak Pulsed Input & Output Current	I <sub>IM</sub> , I <sub>OM</sub>	2	A
Maximum Voltage applied to V <sub>OUT</sub>	V <sub>OUT(max)</sub>	Smaller of V <sub>IN</sub> +12V or 18V	V

**Maximum Current at V<sub>IN</sub> = 48V** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Continuous Output Current (Note 7)	I <sub>OUT</sub>	60	mA
Pulsed Output Current (Note 8)	I <sub>OM</sub>	960	mA
(Note 9)		200	

**Thermal Characteristics**

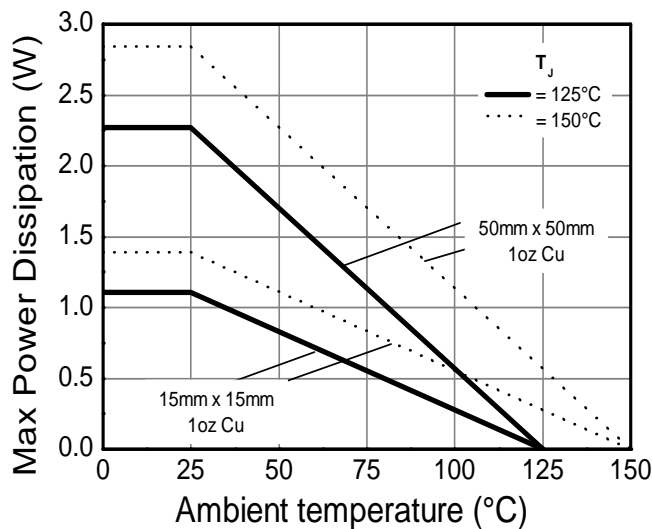
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	2.3	W
(Note 6)		1.1	
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	44	°C/W
(Note 6)		90	
Thermal Resistance, Junction to Lead (Note 10)	R <sub>θJL</sub>	8.4	
Thermal Resistance, Junction to Case (Note 10)	R <sub>θJC</sub>	14.6	
Recommended Operating Junction Temperature Range	T <sub>J</sub>	-40 to +125	°C
Maximum Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	

**ESD Ratings** (Note 11)

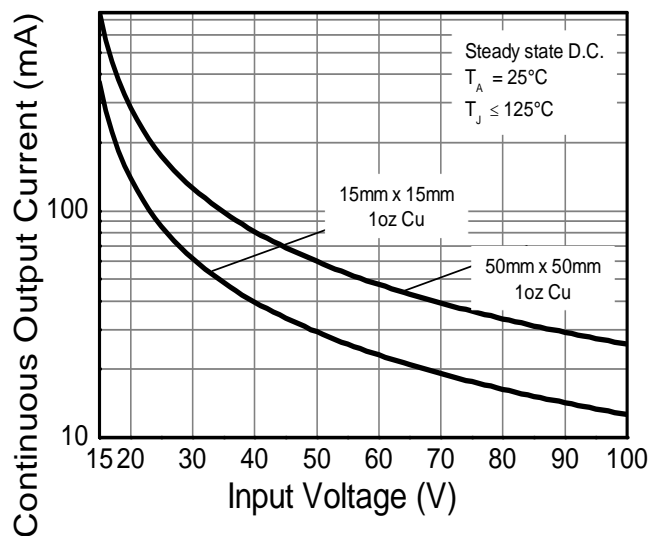
Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the exposed V<sub>IN</sub> pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
  - Same as note 5, except mounted on 15mm x 15mm 1oz copper.
  - Same as note 5, whilst operating at V<sub>IN</sub> = 48V. Refer to Safe Operating Area for other Input Voltages.
  - Same as note 5, except measured with a single pulse width = 100μs and V<sub>IN</sub> = 48V.
  - Same as note 5, except measured with a single pulse width = 10ms and V<sub>IN</sub> = 48V.
  - R<sub>θJL</sub> = Thermal resistance from junction to solder-point (on the exposed V<sub>IN</sub> pad).
  - R<sub>θJC</sub> = Thermal resistance from junction to the top of case.
  - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

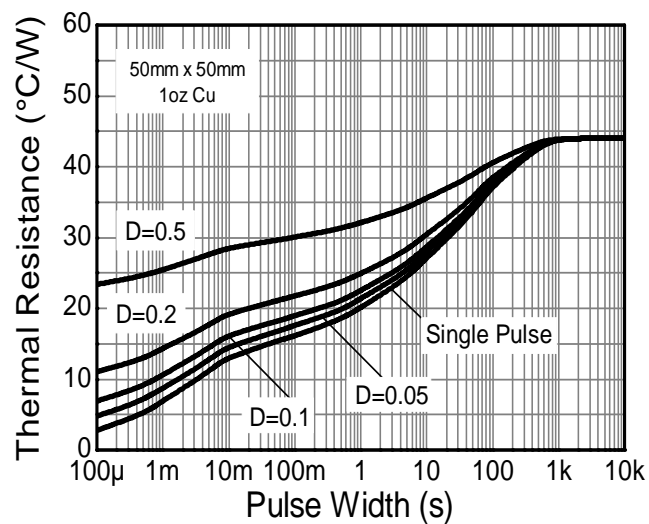
## Thermal Characteristics and Derating Information



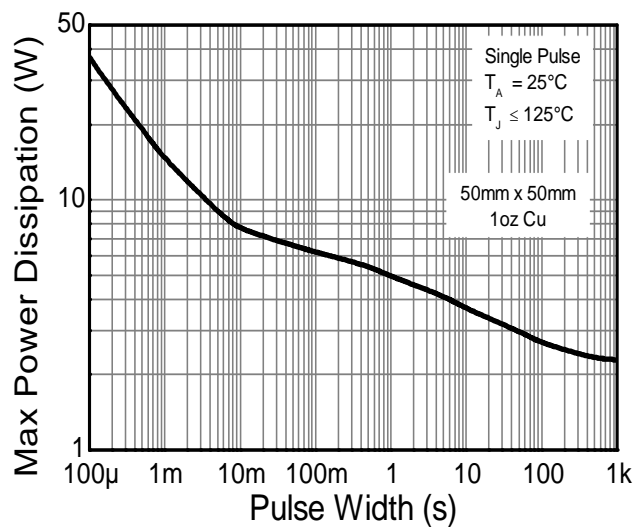
**Derating Curve**



**Safe Operating Area**



**Transient Thermal Impedance**



**Pulse Power Dissipation**

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V <sub>OUT</sub>	10.8	12	13.2	V	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Line Regulation (Notes 12 & 13)	ΔV <sub>OUT</sub>	—	240	750	mV	V <sub>IN</sub> = 15 to 72V, I <sub>OUT</sub> = 15mA
Temperature Coefficient	ΔV <sub>OUT</sub> /ΔT	—	8.0	—	mV/°C	T <sub>J</sub> = -40°C to +125°C V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 15mA
Load Regulation (Notes 12 & 14)	ΔV <sub>OUT</sub>	—	-450 -600	-600 -750	mV	I <sub>OUT</sub> = 0.1 to 30mA, V <sub>IN</sub> = 48V I <sub>OUT</sub> = 0.1 to 100mA, V <sub>IN</sub> = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V <sub>IN(MIN)</sub>	15	—	—	V	—
Quiescent Current	I <sub>Q</sub>	—	240 590	400 900	μA	V <sub>IN</sub> = 48V, I <sub>OUT</sub> = 10μA V <sub>IN</sub> = 100V, I <sub>OUT</sub> = 10μA
Power Supply Rejection Ratio	ΔV <sub>IN</sub> /ΔV <sub>OUT</sub>	—	45	—	dB	C <sub>OUT</sub> = 100nF, I <sub>OUT</sub> = 15mA, V <sub>OUT</sub> = 12V, V <sub>IN</sub> = 15 to 100V, f = 100Hz

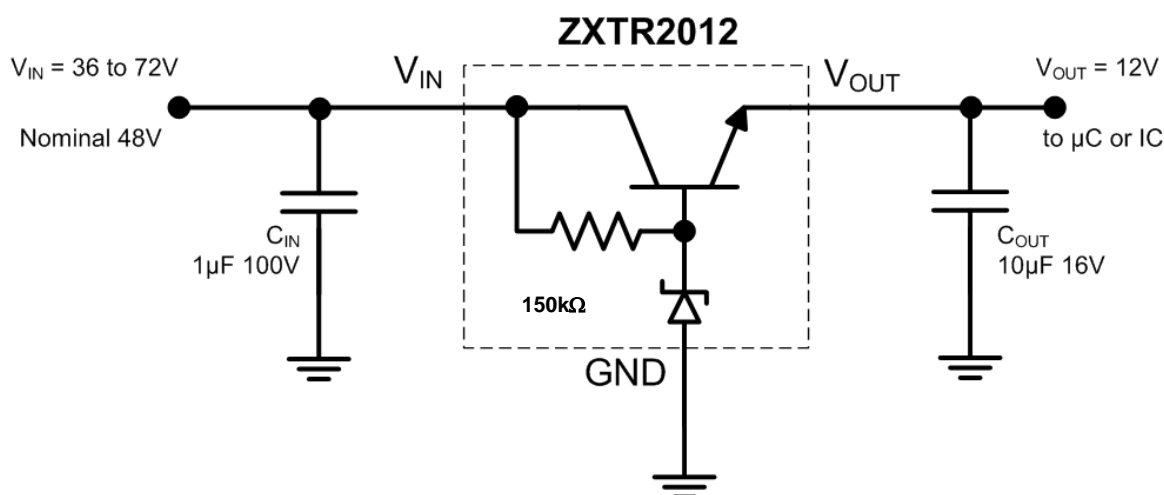
Notes:

12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%

13. Line regulation ΔV<sub>OUT</sub> = V<sub>OUT</sub>(@ V<sub>IN</sub> = 72V) - V<sub>OUT</sub>(@ V<sub>IN</sub> = 15V)

14. Load regulation ΔV<sub>OUT</sub> = V<sub>OUT</sub>(@ I<sub>OUT</sub> = 30mA) - V<sub>OUT</sub>(@ I<sub>OUT</sub> = 0.1mA)  
ΔV<sub>OUT</sub> = V<sub>OUT</sub>(@ I<sub>OUT</sub> = 100mA) - V<sub>OUT</sub>(@ I<sub>OUT</sub> = 0.1mA)

## Typical Application Circuit

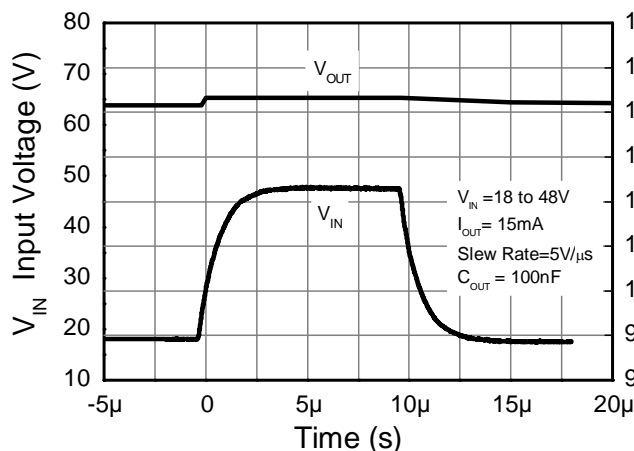


Example of an 12V regulated supply from a nominal 48V for powering a Controller IC.

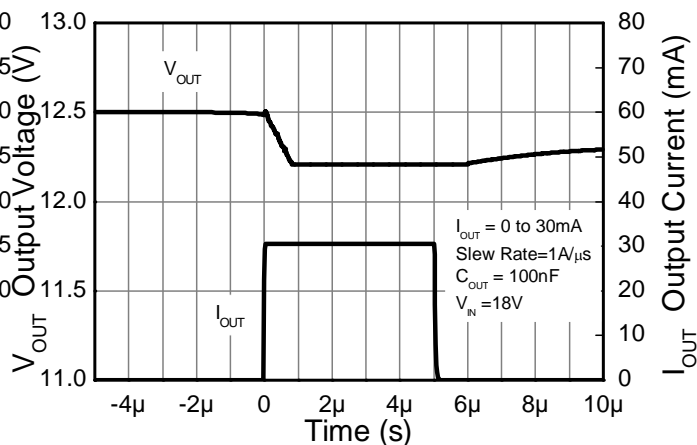
## Pin Functions

Pin Name	Pin Function	Notes
V <sub>IN</sub>	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V <sub>OUT</sub> regulated then 15V ≤ V <sub>IN</sub> ≤ 100V. It is recommended to connect a 1μF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V <sub>OUT</sub>	Voltage Output	Outputs a regulated 12V when 15V ≤ V <sub>IN</sub> ≤ 100V. When V <sub>IN</sub> < 15V, then V <sub>OUT</sub> maximum = V <sub>IN</sub> - 1.5V. The pin can be pulled high to a maximum of +18V with respect to GND, or +12V with respect to V <sub>IN</sub> , whichever is lower. It is recommended to connect a 10μF capacitor to GND and a minimum of 10μA to be drawn from V <sub>OUT</sub> to maintain regulation.

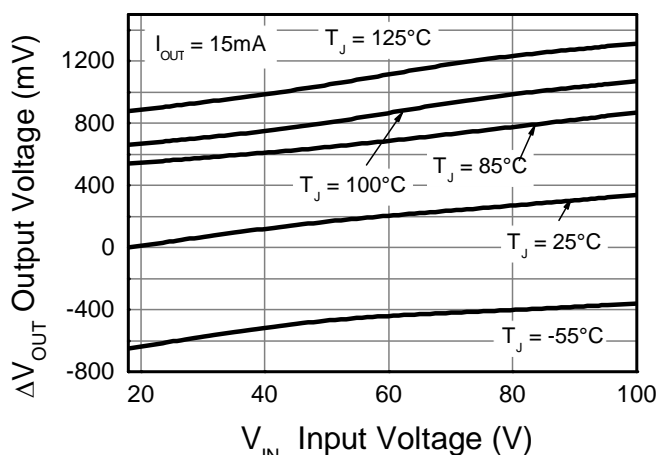
**Typical Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)



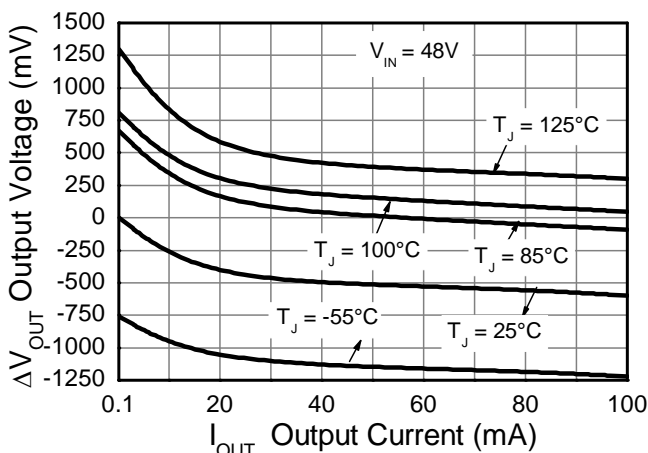
**Line transient response**



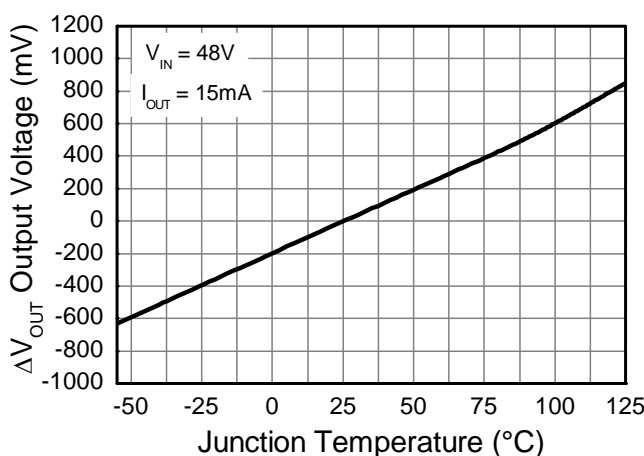
**Load transient response**



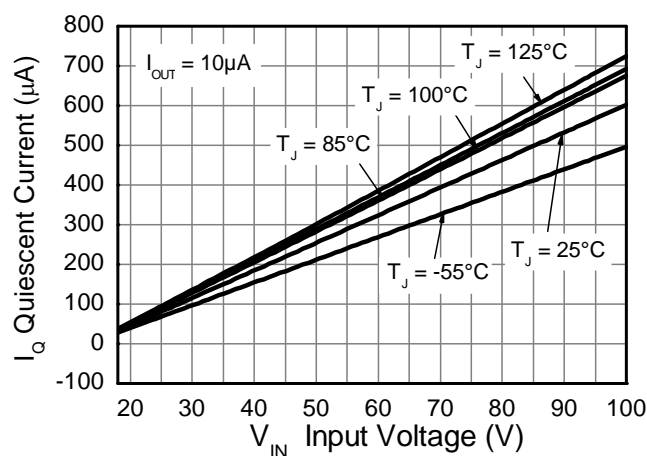
**Line Regulation (Note 15)**



**Load Regulation (Note 16)**



**Temperature Coefficient (Note 17)**

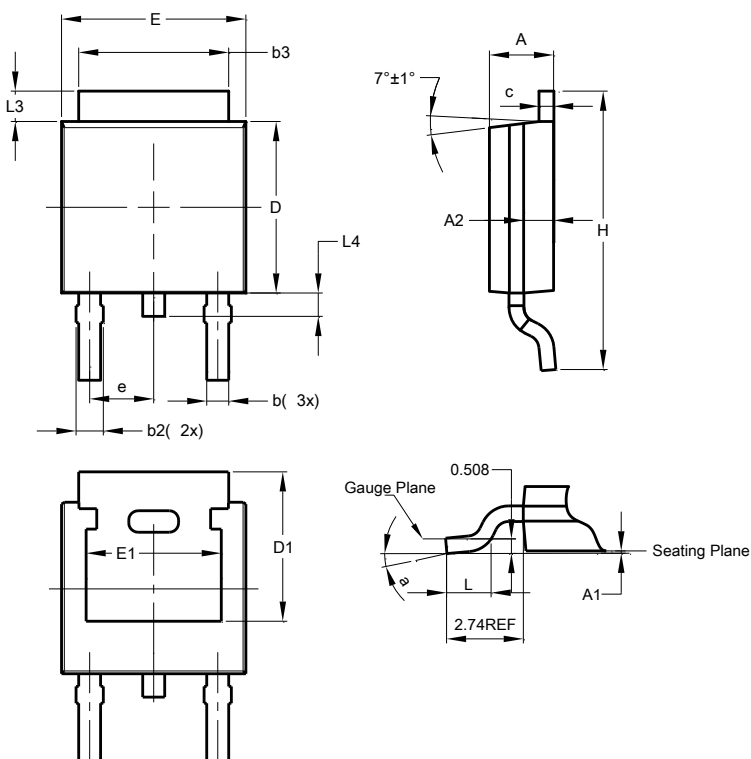


**Quiescent Current**

Notes:  
15. Line regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 15\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$   
16. Load regulation  $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 48\text{V}, I_{OUT} = 0.1\text{mA}, T_J = +25^\circ\text{C})$   
17. Temperature Coefficient  $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 48\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$

## Package Outline Dimensions

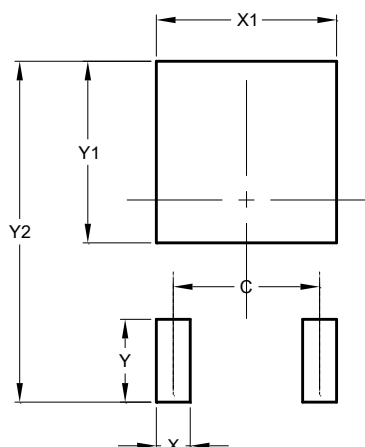
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	-
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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